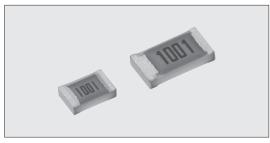


LT73 Linear Positive Temp. Coefficient Flat Chip Resistors



Coating color : Orange

Features

- SMD thin film resistors with thermo-perceptivity.
- Various TCRs +150~+4500× 10^{-6} /K are available.
- Suitable for both flow and reflow soldering.
- Products with lead free termination meet EU-RoHS requirements.

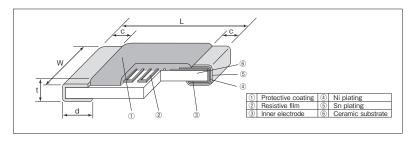
Application

• Suitable for temperature control in various industrial equipment.

■Reference Standards

IEC 60115-8 JIS C 5201-8

■Construction



Dimensions

	Туре		Weight (g)				
(Inch Size Code)		L±0.2	W±0.2	С	d ^{+0.2} -0.1	t±0.1	(1000pcs)
	2A (0805)	2.0	1.25	0.4±0.2	0.3	0.5	4.54
	2B (1206)	3.2	1.6	0.5±0.3	0.4	0.6	9.14

■Type Designation

Examples

LT73	2B	Т	TD	202	J	0150
Product	Size	Terminal	Taping	Nominal	Resistance	T.C.R.
Code		Surface Material		Resistance	Tolerance	(×10 ⁻⁶ /K)
	2A:2.0×1.25mm	T:Sn	TD:4mm pitch	3 digits	G:±2%	4 digits
	2B:3.2×1.6mm		paper		J:±5%	
			TE:4mm pitch			
			plastic			
			embossed			
			BK:Bulk			

The terminal surface material lead free is standard.

Contact us when you have control request for environmental hazardous material other than the substance specified by EU-RoHS. For further information on taping, please refer to APPENDIX C on the back pages.

Ratings

Туре	Power Rating	Max. Working Voltage*1	Max. Overload Voltage	Thermal Time Constant**2	Thermal Dissipation Constant**2	Rated Ambient Temperature	Operating Temperature Range	Taping & Q'ty/Reel (pcs)	
	(W)	(V)	(V)	(s)	(mW/℃)	(℃)	(°C)	TD	TE
2A	0.1	50	100	1.0	1.37	+70	-40~+125	5,000	4,000
2B	0.125	75	150	1.5	1.47			5,000	4,000

^{%1} Rated voltage=√Power Rating×Resistance value or Max. working voltage, whichever is lower.

■T.C.R. and Resistance Range

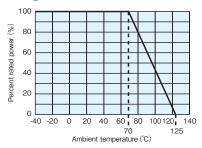
T.C.R. (×10 ⁻⁶ /K)**3	TORTHUM	Resistance Ra	Resistance Tolerance	
1.C.H. (X10 /K)	T.C.R.Tolerance	2A	2B	(%)
150 • 250 • 350 • 450 • 500	±100×10 ⁻⁶ /K	2k~24k	2k~51k	G:±2
600 • 700 • 800 • 900	±150×10 ⁻⁶ /K	1k~20k	1k~43k	
1000 • 1200 • 1400	±15%	1k~13k	1k~27k	
1600 • 1800	±15%	510~4.7k	1k~10k	
2000 • 2200 • 2400		510~4.7k	510~9.1k	J:±5
2600 • 2800 • 3000		510~3k	510∼6.2k	J:±5
3300 • 3600 • 3900	±10%	510~3k		
4200		100∼1k	100~2k	
4500		51~510	51~510	

 $\%3\,$ T.C.R. Measuring Temperature: $+25 \ensuremath{\mathbb{C}}/+75 \ensuremath{\mathbb{C}}$

^{*2} Thermal time constant and dissipation constant are reference values, which are values of elements and vary with connecting or fixing methods.

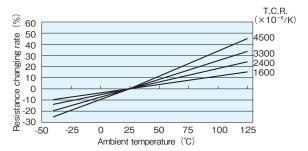


Derating Curve



For resistors operated at an ambient temperature of 70°C or higher, the power shall be derated in accordance with the above derating curve.

■Examples of Temperature Characteristics of Resistance



■Approximate Expression for Resistance-Temperature Characteristics

(Values are not guaranteed but typical.)

R_T=R₂₅ (C₀+C₁T+C₂T²)

RT: Resistance value at $T^{\circ}C$ R25: Resistance value at $25^{\circ}C$ T: Ambient temperature (°C) C0, C1, C2: Constants

1.C.H. (×10 ⁻⁶ /K)	C _o	C ₁	C ₂
3000	0.9288	0.0028	1.9983×10 ⁻⁶
3300	0.9232	0.0030	2.9980×10 ⁻⁶
3600	0.9175	0.0032	4.0000×10 ⁻⁶
3900	0.9099	0.0035	4.0064×10 ⁻⁶
4200	0.9026	0.0038	3.9964×10 ⁻⁶
4500	0.8948	0.0041	4.0064×10 ⁻⁶

■Performance

Test Items	Performance Requirements $\Delta R \pm (\%+0.05\Omega)$		Test Methods	
rest items	Limit	Typical	Test Methods	
Resistance	Within specified tolerance	_	25℃	
T.C.R.	Within specified T.C.R.		+25℃/+75℃	
Overload(Short time)	1	0.23	Rated voltage × 2.5 or Max. overload vol. for 5s, whichever is lower.	
Resistance to soldering heat	1	0.10	260°C±5°C, 10s±1s	
Rapid change of temperature	1	0.10	-40°C (30min.) /+125°C (30min.) 5 cycles	
Moisture resistance	3	0.54	40℃±2℃, 90%~95%RH, 1000h	
Worsture resistance	3	0.54	1.5h ON/0.5h OFF cycle	
Endurance at 70°C	3	0.62	70°C±2°C, 1000h	
Litarance at 700		0.02	1.5h ON/0.5h OFF cycle	

Confirming resistance drift is recommended since this product has a tendency to have bigger resistance change than general flat chip over 70°C. Please pay attention not to be applied ESD, it may cause of resistance change.

Actual Value (Out of guarantee)

Т	est Items	Reference	Test Methods
L	ow temperature exposure	0.05%	-40°C, 45min
H	ligh temperature exposure	0.6%	+125℃, 1000h
Е	ESD	500V	Human body model, 100pF, 1.5kΩ

■Precautions for Use

the implementation.

- The resistance value of this resistor changes by its self-heating by power applied. Therefore, it is recommended to use it by taking its self heat-generation into consideration.
- Ionic impurities such as flux etc. that are attached to these products or those mounted onto a PCB, negatively affect their moisture resistance, corrosion resistance, etc. The flux may contain ionic substances like chlorine, acid, etc. while perspiration and saliva include ionic impurities like sodium (Na*), chlorine (Cl*) etc. Therefore these kinds of ionic substances may induce electrolytic corrosion when they invade into the products. Either thorough washing or using RMA solder and flux are necessary since lead free solder contains ionic substances. Washing process is needed, before putting on moisture proof material in order to prevent electrolytic corrosion.
- An overcurrent such as surge, etc.may break the metal film of LT73.
- When heat-resistant masking tapes are attached to the chip resistors at the time of mounting and then detached, there is a possibility of exfoliation of the top electrodes. It is known that the heat applied in the mounting process will enhance the adhesion strength of the tape adhesive so please avoid the use. If the use of masking tapes are unavoidable, then please be sure not to attach the tape adhesives directly on the products.

 When high-pressure shower cleaning is implemented, there is a possibility of exfoliation of the top electrodes caused by the water pressure stress so please avoid

If the implementation is unavoidable, then please evaluate the products beforehand.